Remarks

Claims 48-54 have been cancelled and new claims 55-69 have been added leaving claims 55-69 pending in the application. No new matter has been added through the addition of claims 55-69. Claims 55-69 are supported by the specification at, for example, the Figure, and pages 3-8. Applicant requests examination of claims 55-69.

Claim 55 recites a method of forming a conductive material that includes depositing a second conductive material against a first conductive material, with the second conductive material consisting essentially of a metal and being different from the first conductive material, and without an insulative composition between the first and second conductive materials. For at least the reason the cited references do not teach or suggest these features, claim 55 is allowable.

Claims 56-59 depend from claim 55 and are allowable for at least the reasons stated above regarding claim 55.

Claim 60 recites a method of forming a conductive material that includes depositing the released metal from one or more metallo-organic precursors over a tungsten-comprising layer. For at least the reason the cited references do not teach or suggest these features, claim 60 is allowable.

Claims 62-65 depend from claim 60 and are allowable for at least the reasons stated above regarding claim 60.

Claim 66 recites a method of forming a conductive material that includes exposing one or more metallo-organic precursors to a reducing atmosphere to release metal from at least one of said precursors, with one or more of the precursors comprising carbon and one or more of Co, Pd, and Ni. For at least the reason the cited references do not teach or

suggest these features, claim 66 is allowable.

Claims 67-69 depend from claim 66 and are allowable for at least the reasons stated above regarding claim 66.

Applicant submits a copy of the Supplemental Information Disclosure Statement filed July 14, 2003 and respectfully requests Examiner's citation of these references.

Claims 55-69 are believed to be in immediate condition for allowance. Applicant requests allowance of claims 55-69 in the Examiner's next Action.

Respectfully submitted,

Dated: 6/18/04

y: _____

Reg. No. 46,791

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